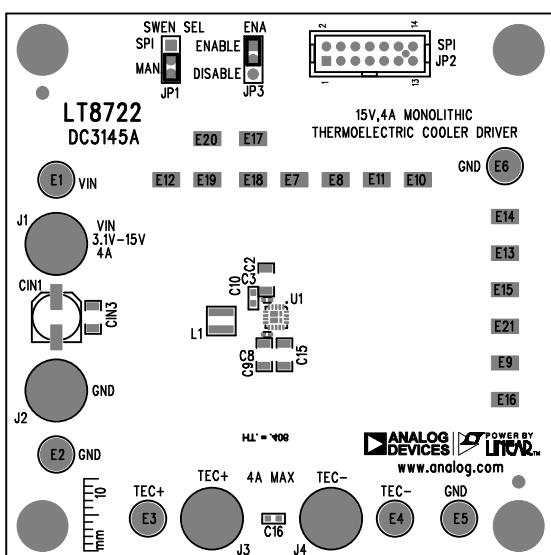
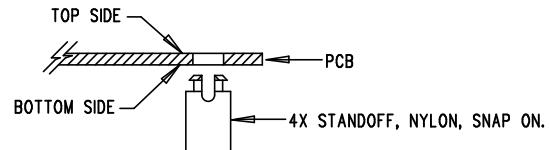


REVISION HISTORY				
ECO	REV	DESCRIPTION	APP. ENG.	DATE
-	3	PRODUCTION	CHARLES R.	01-28-21



NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELSIUS.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN IN ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.
7. INSTALL STANDOFFS AS SHOWN BELOW:



APPROVALS		ANALOG DEVICES POWER BY LINEAR™		FOR ADI CUSTOMER USE ONLY
PCB DES.	LT			
APP ENG.	CHARLES R.			TITLE: ASSEMBLY DRAWING, TOP
				15V,5A MONOLITHIC THERMOELECTRIC COOLER DRIVER
		SCALE = NONE	SIZE N/A	IC NO. LT8722LQFN DC3145A
				REV 3
		FILENAME: DC3145A-3.PCB		SHT 1 OF 2